TUSB8044RGCEVM INT077-001 Bill Of Materials							
Texas	Instrumen	ts					
Item	Quantity	Reference	Part	Manufacturer	Part Number	Pkg	Description
1	. 1	C5	1uF	Murata	GRM219R61A105KA01D	805	1μF ±10% 10V Ceramic Capacitor X5R 0805 (2012 Metric)
2		C3	1uF	Samsung	CL05B105KQ5NQNC	402	CAP CER 1UF 6.3V 10% X7R 0402
3	5	C39,C47,C49,C57,C59	0.001uF	TDK	C1005X7R1H102K	402	CAP CER 1000PF 50V X7R 10% 0402
4	. 9	C6,C9,C12,C15,C19,C22,	0.001uF	TDK	C0603X7R1E102K030BA	201	CAP CER 1000PF 25V 10% X7R 0201
		C25,C28,C32,					
- 5	9	C7,C10,C13,C16,C20,C23,C26,	0.01uF	Yageo	CC0201KRX7R7BB103	201	CAP CER 10000PF 16V 10% X7R 0201
		C29,C33	0.0141	Togeo	CCCLC IIII/// N/ DD 105	201	GW 6EW 1000011 10V 10/W/W 0E01
	10	C4,C38,C40,C41,C46,C48,C50,	0.1uF	Yageo	CC0402KRX5R6BB104	402	CAP CERAMIC .1UF 10V X5R 0402
	10	C51.C56.C58.C66.C69.C72.C75.	0.10	rageo	CC0402KKA3K0BB104	402	CAF CERAIVIIC .TOF 10V ASK 0402
		C77,C78,C80,C81					
<del>-</del>	40	* * *	0.1uF	ТДК	C0603X5R0J104M	201	CAR CER AGUE C DAVER COOL
<del></del>	19	C8,C11,C14,C17,C21,C24,C27,	0.1ur	TDK	CU6U3X5KUJ1U4IVI	201	CAP CER .10UF 6.3V X5R 0201
		C30,C34,C36,C37,C42,C43,C44,					
		C45,C52,C53,C54,C55					
8		C1,C2	18pF	AVX	04025A180JAT2A	402	CAP CERM 18PF 5% 50V NP0 0402
9	9	C18,C31,C35,C61,C67,C68,	10uF	Murata Electronics	GRM31CR61C106KA88L	1206	CAPACITOR CERM 10UF 16V 10% SMD
		C73,C74,C82	+				
					T495D157K010ATE100		
10		C70,C71,C76,C79	150uF	Kemet	(Tantalum)	7343	CAP TANT 150UF 10V 10% LOESR SMD
11		R10,R32,R42,R43,R44,R45	NOPOP			402	
12		D1,D4,D5,D6,D7,D8	LED Green 0805	Lite On	LTST-C171GKT	805	LED GREEN CLEAR THIN 0805 SMD
13		D2,D3	LED Green 0805 - NOPOP	Lite On	LTST-C171GKT	805	LED GREEN CLEAR THIN 0805 SMD
14 15		FB1,FB3,FB4,FB5,FB6	220 @ 100MHZ Ferrite Bead	Murata	BLM18PG221SN1D	603	FERRITE CHIP 220 OHM 1400MA 0603
		SW1,SW2	8-POS 50-MIL SMT	C&K Components	SD08H0SBR		SWITCH DIP SPST SEALED 8POS SMD
16		J1	USB3_TYPEB_CONNECTOR	Amphenol	GSB321131HR	9_RA_TH_B	CONN RCPT USB 3.0 TYPE B R/A 9PS
17		J2,J3,J4,J5 J6	USB3_TYPEA_CONNECTOR	Amphenol	GSB311131HR	9_RA_TH_A	CONN RCPT USB 3.0 TYPE A R/A 9PS
18 19			2.1mm x 5.5mm DC Power Jack 1M	CUI Inc.	PJ-202AH	2.1mm x 5.5mm 402	CONN PWR JACK 2.1X5.5MM HIGH CUR
		R1,R15,R17,R18,R19,R20 R2		Rohm Semiconductor	MCR01MZPJ105		RES 1.0M OHM 1/16W 5% 0402 SMD
20			90.9K 1% 10K	Rohm Semiconductor	MCR01MZPF9092	402 402	RES 90.9K OHM 1/16W 1% 0402 SMD
21 22		R26,R27,R29,R36	10K 1%	Rohm Semiconductor Rohm Semiconductor	MCR01MZPJ103 MCR01MZPF1002	402	RES 10K OHM 1/16W 5% 0402 SMD RES 10K OHM 1/16W 1% 0402 SMD
23		R6,R7,R8,R9	4.7K		MCR01MZPJ472	402	RES 4.7K OHM 1/16W 1% 0402 SMD
23		R4,R5,R11,R12,R13,R14,R22,R23,	1K	Rohm Semiconductor	MCR01MZPJ102	402	RES 1.0K OHM 1/16W 5% 0402 SMD RES 1.0K OHM 1/16W 5% 0402 SMD
	15	R24,R25,R13,R12,R13,R14,R22,R23,	11/	Rohm Semiconductor	INICRO1INIZPJ102	402	RES 1.0K UNIVI 1/10W 5% 0402 SIVID
25		R16,R28,R30,R31,R35,R37,	330	Rohm Semiconductor	MCR01MZPJ331	402	RES 330 OHM 1/16W 5% 0402 SMD
	+ - •	R10,R28,R30,R31,R35,R37,	330	Rollin Semiconductor	IVICRUTIVIZPJ331	402	RES 330 ORIVI 1/10W 5% 0402 SIVID
26	1	R33	1.87K	Vishay / Dale	CRCW04021K87FKED	402	RES 1.87K OHM 1/16W 1% 0402 SMD
27		R34	4.99K	Vishay / Dale	CRCW04021K87FKED	402	RES 4.99K OHM 1/16W 1% 0402 SMD
28		R21	9.53K 1%	Rohm Semiconductor	MCR01MRTF9531	402	RES 9.53K OHM 1/16W 1% 0402 SMD
29		U1	TUSB8044 - USB 3.0 Hub	Texas Instruments	TUSB8044RGC	64QFN	RES 5.35K OHIVI 1/10W 1/6 0402 SIVID
30		U2	AT24C04 I2C EEPROM	Assmann WSW Components	A 08-LC-TR	8DIP	CONN IC DIP SOCKET 8POS TIN
31		U7,U8,U9,U10	TPS2001C	Texas Instruments	TPS2001CDGN	8DGN	IC PWR SW USB 2.87A 1CH 8MSOP
32		U4	TPS7A4533 - 3.3V Voltage Regulator	Texas Instruments	TPS7A4533KTT	DDPAK-5	IC REG LDO 3.3V 1.5A 5-DDPAK
33		U6	TPS74801RGW - 1.1V Voltage Regulator	Texas Instruments	TPS74801RGW	20VQFN	IC REG LDO ADJ 1.5A 20VQFN
34		Y1	ECS-24MHZ Crystal	ECS	ECS-240-20-30B-TR	5.0mm x 3.2mm	CRYSTAL 24.000 MHZ 20PF SMD
35			PCB Standoff	Keystone Electronics	2203	3.511111 X 3.211111	HEX STANDOFF 4-40 ALUMINUM 1/2"
36			Screw	Keystone Electronics	9900		MACHINE SCREW PAN PHILLIPS 4-40
37		FB2	0 ohm	Yageo	RC0603JR-070RL	603	RES 0.0 OHM 1/10W 0603 SMD
38		JP6	Conn 2x5 shroud - NO POP	3M	2510-6003UB	HDR5X2 M 0.1" TH	
39		J7,J8,J9,J10,J11,J12	Header 1x2	3M	961102-6404-AR	HDR2X1 M 0.1" TH	CONN HEADER VERT SGL 2POS GOLD
40		J13	Header 3PIN	3M	961102-6404-AR	HDR2X1 M 0.1" TH	CONN HEADER VERT SGL 2POS GOLD
41	1	SW3	Power Switch - L101011MS02Q		L101011MS02Q	SPST	COMMINE IDENTIFICATION OF EACH OF GOLD
41		GND1, GND2	NOPOP	C&K Components	LIUIUIIWSUZŲ	3531	
43		LB1	sticker	3M	695-WHITE-2"X36YD	<del> </del>	add text: TUSB8044RGCEVM INT077-001 REV A
44		Shunt	Shunt	3M	969102-0000-DA	<del> </del>	Place shunts on: J7,J8,J9,J10,J11,J12
45		PCB BOARDS	TUSB8044RGCEVM	Jivi	INT077-001	<u> </u>	TUSB8044RGCEVM PCBBOARD
	1 1	1. 00 00,1100	I - O D D O O T T I T O C L V I V I	1	077-001	1	- OSSOCGCEVIVI I CODOARD

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